

Page 9, line 14, delete "gate U9, 10. 11" and substitute therefore ---gates U9, U10 and U11---.

Page 10, line 3, delete "21, 22, 23, 24, and 25" and substitute therefore ---U21, U22, U23, U24, and U25---.

Page 10, line 7, delete "gate U2 1, 22" and substitute therefore --- gates U21, and U22---

Page 10, line 11, delete "18" and substitute therefore ---U18--
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Page 10, line 20, before "When" insert paragraph indentation

Page 11, line 4, delete "6" and substitute therefore ---U6---

Page 11, line 26, delete "21" and substitute therefore ---
U21---

Page 12, line 2, delete "24" and substitute therefore ---U24--
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Page 12, line 14, delete "41" and substitute therefore ---U41--
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Page 12, line 15, delete "38" and substitute therefore ---U38--
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Page 12, line 24, delete "2, 3, 4." and substitute therefore -
--QD2, QD3, QD4.---.

Page 13, line 13, before "In this section" insert paragraph indentation.

Page 17, line 14, after "2 μ " insert ---second---

Page 17, line 23, delete "was" and substitute therefore ---
were---

Page 18, line 21, delete "10 μ The" and substitute therefore
---10 μ . The---

Page 19, line 16, delete "US" and substitute therefore ---U5--
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Page 19, line 25, before "The most" insert paragraph
indentation

Page 20, line 1, delete "Figure 9" and substitute therefore --
-Figure 11---

Page 21, line 10, delete "1 kOhm pull down resistor used." and
substitute therefore ---1k Ohm pull down resistor was used.---

Page 23, line 7, delete "PMOS" and substitute therefore ---
CMOS---

Page 23, line 8, delete "Applicant is not sure if this action
was correct as there was no funding available to carry out further
simulations."

Page 23, line 10, delete "increase" and substitute therefore -
--increased---.

Page 23, line 15, delete "This effect will be investigated
during the second design project before the design of the next
MicroTAG chip is started."

Page 24, lines 16-19, delete "Using a strong glue and chemical
and/or heat treatment to remove it. In view of the large scale of
the project, this does not appear to be a realistic option. Also,
any such treatment would likely damage some of the materials
involved, especially plastics."